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Data Sheet

November 2013

# 30 A, 200 V, Ultrafast Dual Diode

## **Description**

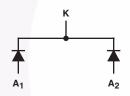
The RURG3020CC is an ultrafast dual diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

# **Ordering Information**

PART NUMBER		PACKAGE	BRAND	
R	URG3020CC	TO-247	RURG3020C	

NOTE: When ordering, use the entire part number.

# Symbol



#### Features

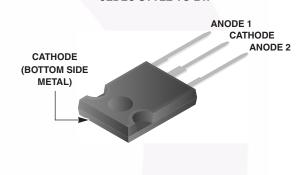
- Ultrafast Recovery  $t_{rr}$  = 50 ns (@  $I_F$  = 30 A)
- Max Forward Voltage, V<sub>F</sub> = 1.0 V (@ T<sub>C</sub> = 25°C)
- Reverse Voltage, V<sub>RRM</sub> = 200 V
- · Avalanche Energy Rated
- RoHS Compliant

### **Applications**

- Switching Power Supplies
- Power Switching Circuits
- · General Purpose

#### **Packaging**

#### **JEDEC STYLE TO-247**



#### **Absolute Maximum Ratings** (Per Leg) T<sub>C</sub> = 25°C

	RURG3020CC	UNIT
Peak Repetitive Reverse Voltage	200	V
Working Peak Reverse Voltage	200	V
DC Blocking Voltage	200	V
Average Rectified Forward Current (Per Leg)	30	Α
$(T_C = 145^{\circ}C)$		
Repetitive Peak Surge CurrentI <sub>FRM</sub>	70	Α
(Square Wave, 20 kHz)		
Nonrepetitive Peak Surge Current	325	Α
(Halfwave, 1 Phase, 60 Hz)		
Maximum Power Dissipation	125	W
Avalanche Energy (See Figures 7 and 8)	20	mJ
Operating and Storage Temperature	-65 to 175	°C

**Electrical Specifications** (Per Leg) T<sub>C</sub> = 25°C, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
V <sub>F</sub>	I <sub>F</sub> = 30 A	-	-	1.0	V
	$I_F = 30 \text{ A}, T_C = 150^{\circ}\text{C}$	-	-	0.85	V
I <sub>R</sub>	V <sub>R</sub> = 200 V	-	-	250	μΑ
	V <sub>R</sub> = 200 V, T <sub>C</sub> = 150°C	-	-	1	mA
t <sub>rr</sub>	I <sub>F</sub> = 1 A, dI <sub>F</sub> /dt = 100 A/μs	-	-	45	ns
	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 100 A/μs	-	-	50	ns
ta	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 100 A/μs	-	20	-	ns
t <sub>b</sub>	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 100 A/μs	-	15	-	ns
$R_{ heta JC}$		-	-	1.2	°C/W

#### **DEFINITIONS**

 $V_F$  = Instantaneous forward voltage (pw = 300  $\mu$ s, D = 2%).

I<sub>R</sub> = Instantaneous reverse current.

 $T_{rr}$  = Reverse recovery time (See Figure 6), summation of  $t_a + t_b$ .

t<sub>a</sub> = Time to reach peak reverse current (See Figure 6).

 $t_b$  = Time from peak  $I_{RM}$  to projected zero crossing of  $I_{RM}$  based on a straight line from peak  $I_{RM}$  through 25% of  $I_{RM}$  (See Figure 6).

 $R_{\theta JC}$  = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

# **Typical Performance Curves**

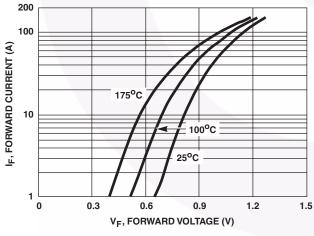


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

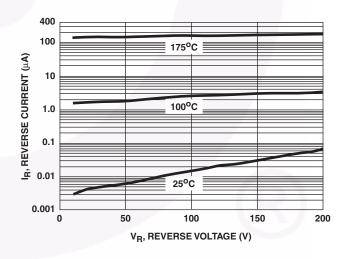


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

# Typical Performance Curves (Continued)

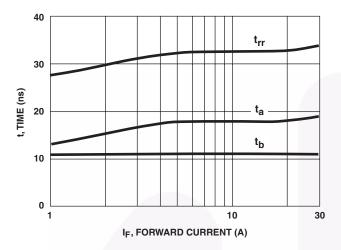


FIGURE 3. t<sub>rp</sub>, t<sub>a</sub> AND t<sub>b</sub> CURVES vs FORWARD CURRENT

# 40 DC DC SQ. WAVE 10 130 140 150 160 170 180 T<sub>C</sub>, CASE TEMPERATURE (°C)

FIGURE 4. CURRENT DERATING CURVE

#### Test Circuits and Waveforms

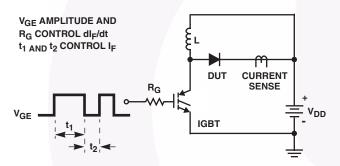


FIGURE 5. t<sub>rr</sub> TEST CIRCUIT

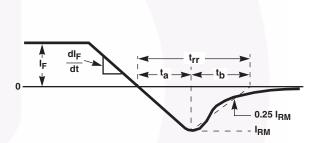


FIGURE 6. t<sub>rr</sub> WAVEFORMS AND DEFINITIONS

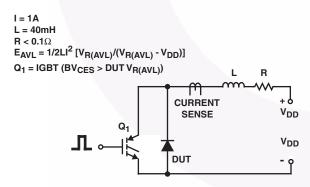


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

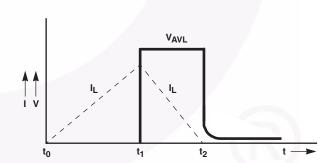
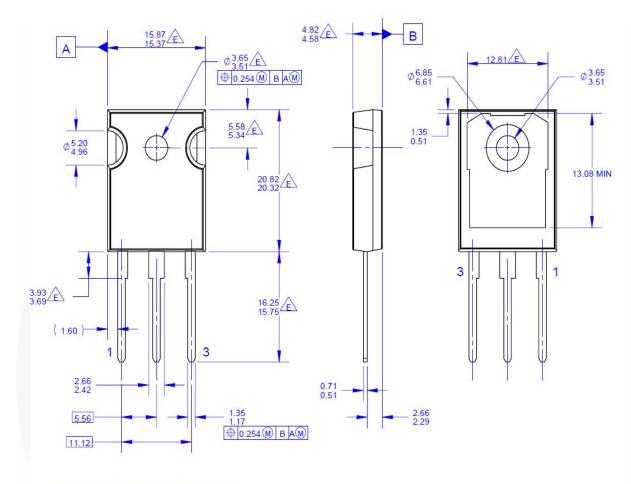


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

# TO247-3L



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004. B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
- FLASH, AND TIE BAR EXTRUSIONS.
- ALL DIMENSIONS ARE IN MILLIMETERS.
  DRAWING CONFORMS TO ASME Y14.5 1994

DOES NOT COMPLY JEDEC STANDARD VALUE DRAWING FILENAME: MKT-TO247A03 REV03

Figure 9. TO-247, Molded, 3LD, Jedec Option AB

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